

Features

- Generates any Telecom or SyncE frequency independent of the input frequency rate
- Two general purpose synthesizers generate a wide range of digital bus clocks
- Programmable digital PLLs synchronizes to any Telecom ($N \times 8 \text{ kHz}$) or any Synchronized Ethernet (SyncE) frequencies.
- Flexible two-stage architecture translates between arbitrary data rates, line coding rates and FEC rates
- Digital PLLs filter jitter from 14 Hz, 28 Hz, 56 Hz, 112 Hz, 224 Hz, 448 Hz or 896 Hz
- Four programmable Numerically Controlled Oscillators (NCOs) available where two NCOs can be used at the time
- Automatic hitless reference switching and digital holdover on reference fail
- Four reference inputs configurable as single ended

Ordering Information

ZL30150GGG	100 Pin LBGA	Trays
ZL30150GGG2	100 Pin LBGA*	Trays

*Pb Free Tin/Silver/Copper
-40°C to +85°C

or differential

- Eight LVPECL outputs and four LVCMOS outputs
- Eight outputs configurable as LVCMOS or LVDS/LVPECL/HCSL
- Operates from a single crystal resonator or clock oscillator
- Configurable via SPI/I2C interface

Applications

- 10 Gigabit line cards
- Synchronous Ethernet, 10 GBASE-R and 10 GBASE-W
- SONET/SDH

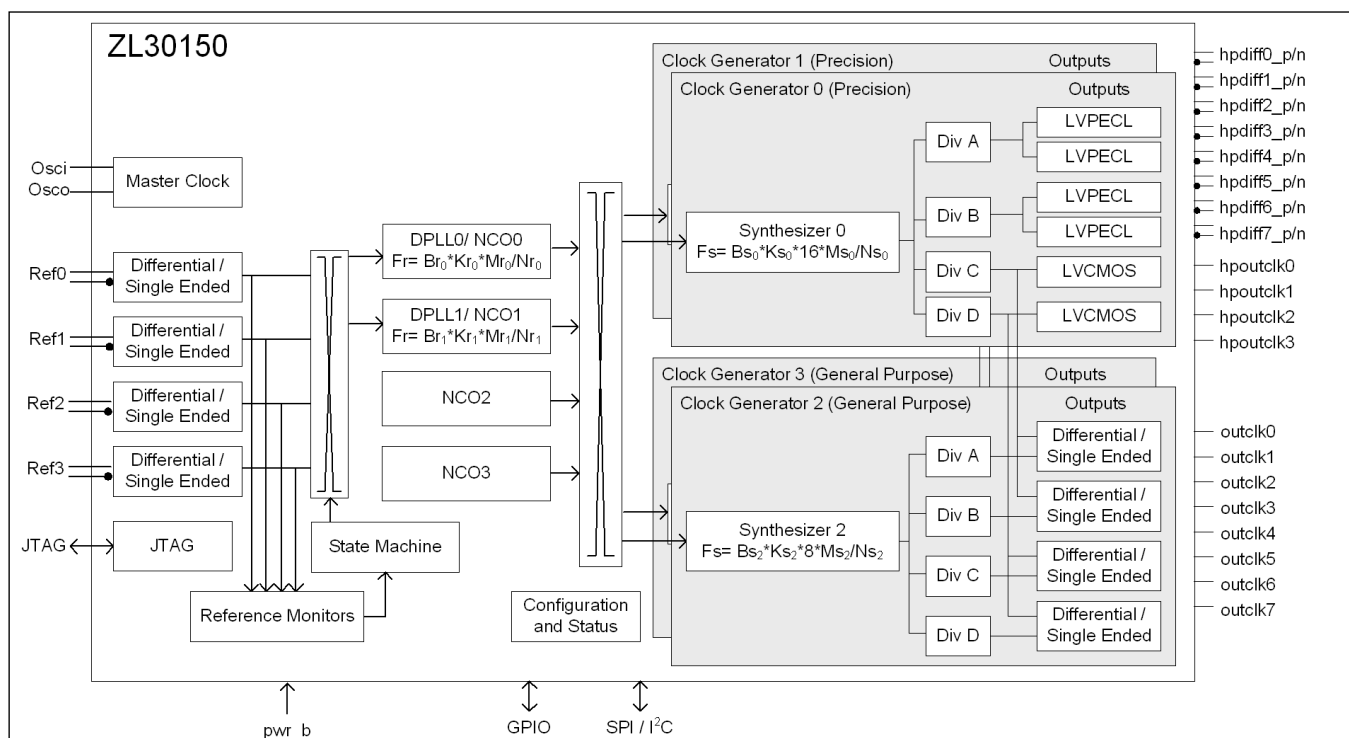
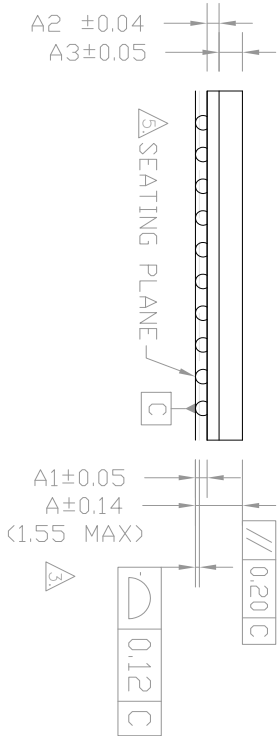
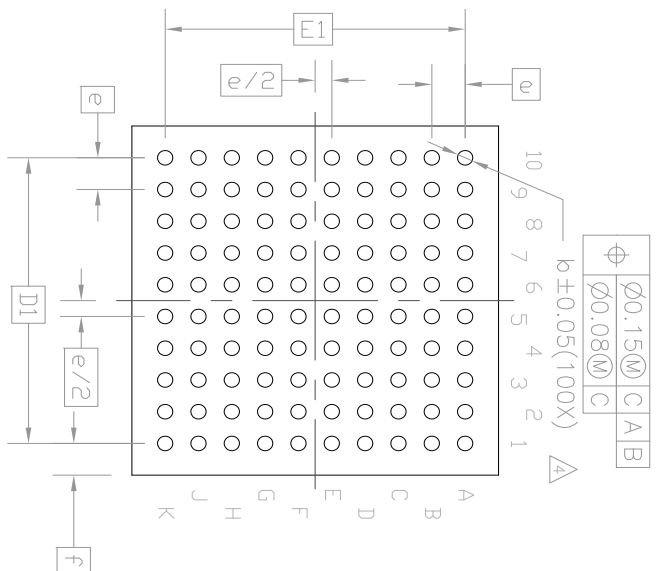


Figure 1 - Functional Block Diagram

Figure 1: Schematic diagram of the proposed PIN identification system. The diagram shows a rectangular PIN pad with 10 columns (1-10) and 4 rows (A-D). A laser beam is directed at the pad, and a camera captures the image. The text "OPTION PIN # A1 IDENTIFIED Ø1.00±0.1 INK DR LASER" is visible on the pad. The system is labeled "PIN 1" and "PIN 2".



- CROWNS OF THE SOLDER BALLS.



SYMBOL	MILLIMETER			INCH		
	MIN	NOM	MAX	MIN	NOM	MAX
A	1.27	1.41	1.55	.050	.056	.061
A1	0.30	0.35	0.40	.012	.014	.016
A2	0.32	0.36	0.40	.013	.014	.016
A3	0.65	0.70	0.75	.026	.028	.029
b	0.40	0.45	0.50	.016	.018	.020
D	10.90	11.00	11.10	.429	.433	.437
D1	9.00	BSC			.354	BSC
E	10.90	11.00	11.10	.429	.433	.437
E1	9.00	BSC			.354	BSC
e	1.00	BSC			.039	BSC
f	0.90	1.00	1.10	0.035	.039	.043

TITLE 100L LBGA PACKAGE OUTLINE BODY SIZE :11X11X1.55MM MAX PITCH 10MM	Microsemi		
		DOC. NO. CDC# 22-0007 84-06-128-332	REV. 4
		SHEET 1 OF 1	SIZES A4



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